















ESD

TVS

MOS

LDO

Diode

Sensor

DC-DC

Product Specification

Domestic Part Number	EV7N65F-T3
Overseas Part Number	7N65F
▶ Equivalent Part Number	7N65F

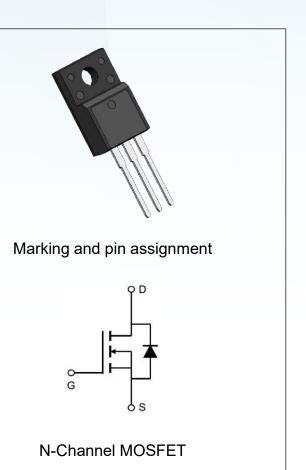
"T3" means TO-220





N-Channel Enhancement Mode Power MOSFET

Description The 7N65F uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate Charge It can be used in a wide variety of applications. **Application** \square Power switching application. ☐ Hard switched and high frequency circuits. ☐ Uninterruptible power supply. **Features** □ VDS =650V, ID =7A \square RDS(ON) : 1.1 Ω @VGS=10V ☐ Low gate charge. \square Green device available. ☐ Advanced high cell denity trench technology for ultra low on-resistance. \square Excellent package for good heat dissipation.



Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	650	V
V _{GS}	Gate Source Voltage	±30	V
I _D @T _C =25℃	Continuous Drain Current ¹	7	А
I _D @T _C =100 ℃	Continuous Drain Current ¹	4.5	A
I _{DM}	Pulsed Drain Current ³	28	А
E _{AS} ,E _{AR}	Avalanche Energy ⁵	49	mJ
I _{AS} ,I _{AR}	Avalanche Current ⁵	14	A
P _D @T _C =25 ℃	Total Power Dissipation ⁴	28	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R _{eJC}	Thermal Resistance, Junction-to-Case ²	3	°C/W
R _{eJA}	Thermal Resistance Junction-Ambient ²	62	°C/W



Electrical Characteristics (TC=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V,I _D =250uA	650			V
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V,I _D =3.5A		1.1	1.2	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} ,I _D =250uA	2	3	4	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =650V,V _{GS} =0V,T _J =25°C			1	uA
1033		V _{DS} =520V,V _{GS} =0V,T _J =100°C			10	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±30V,V _{DS} =0V			±100	nA
g FS	Forward Transconductance	V _{DS} =10V,I _D =3.5A		7		S
Qg	Total Gate Charge (4.5V)	V _{DS} =520V,V _{GS} =10V,I _D =4A		32	48	nC
Q _{gs}	Gate-Source Charge			6.4	10	
Q _{gd}	Gate-Drain Charge			11.8	18	
T _{d(on)}	Turn-On Delay Time	V_{DD} =300V, I_{DS} =4A, V_{GEN} =10V, R_{G} =25 Ω		30	60	
Tr	Rise Time			34	68	
T _{d(off)}	Turn-Off Delay Time			72	144	nS
T _f	Fall Time			28	56	
C _{iss}	Input Capacitance	V _{DS} =30V,V _{GS} =0V,f=1MHz		1676	2995	
Coss	Output Capacitance			135	180	pF
C _{rss}	Reverse Transfer Capacitance			27	50	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Curren1,4	VG=VD=0V			7	Α
I _{SM}	Pulsed Source Current				14	Α
V _{SD}	Diode Forward Voltage2	V _{GS} =0V,I _{SD} =3.5A,T _J =25℃			0.8	V
T _{rr}	Reverse Recovery Time	I _S =3.5A,V _{GS} =10V,	-	210		nS
Q _{rr}	Reverse Recovery Charge	di/dt=100A/µsTJ=25℃		0.85		uC

Notes:

- 1 . Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 1$ 0 sec.
- **3.** Pulse Test: Pulse Width $\leq 300 \,\mu\text{s}$, Duty Cycle $\leq 2 \,\%$.
- 4. The data is theoretically the same as I D and I DM, in real applications, should be limited by total power dissipation.
- 5. The EAS test condition is VDD =30V,VGS =10V,L=0.5mH,IAS =14A



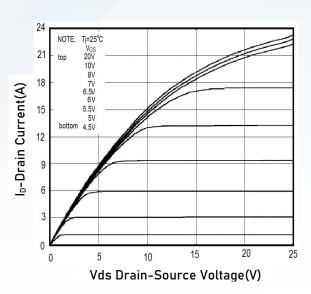


Fig.1 Typical Output Characteristics

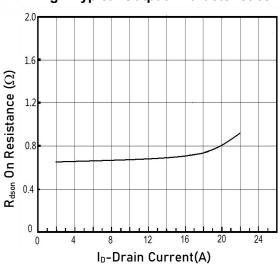


Fig.3 Drain-Source On Resistance

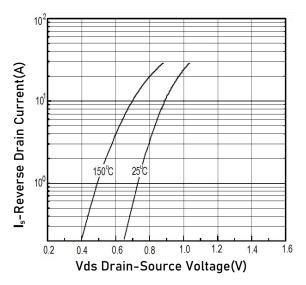


Fig.5 Forward Characteristics Of Reverse

N-Ch 650V Fast Switching MOSFETs

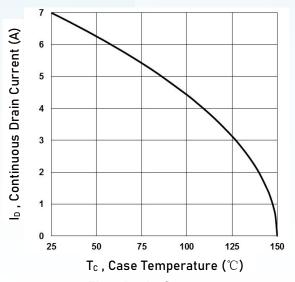


Fig.2 Drain Current

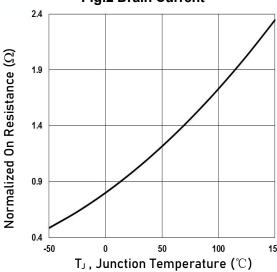


Fig.4 Normalized RDSON vs. TJ

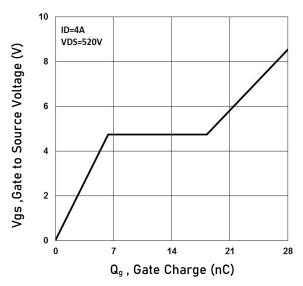
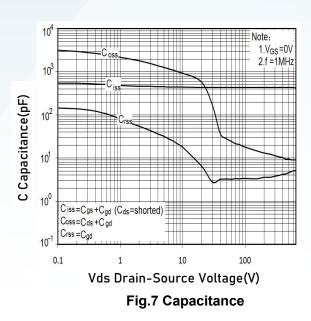


Fig.6 Gate-Charge Characteristics



N-Ch 650V Fast Switching MOSFETs



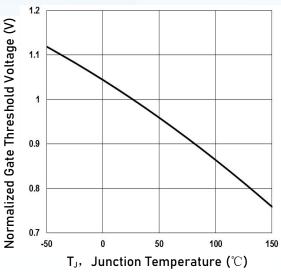


Fig.8 Normalized Vth vs. TJ

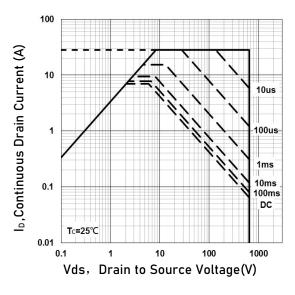


Fig.9 Safe Operating Area

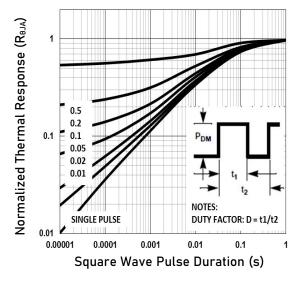
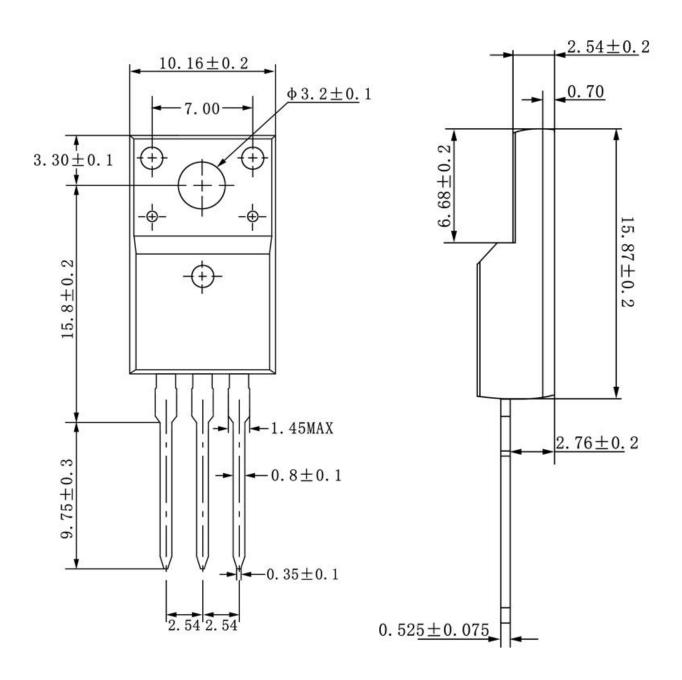


Fig.10 Transient Thermal Impedance



TO-220F Package Information





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